2



Sub-Miniature Slide Switches



SPECIFICATIONS

CONTACT RATING: Dependent upon contact material. MECHANICAL LIFE: 30,000 make-and-break cycles. CONTACT RESISTANCE: $20m\Omega$ max. initial @ 2-4VDC 100mA for both silver and gold plated contacts.

INSULATION RESISTANCE: $1,000M\,\Omega$ min. DIELETRIC STRENGTH: 1,000 V RMS@sea level. OPERATING TEMPERATURE: -30° C to 85° C.

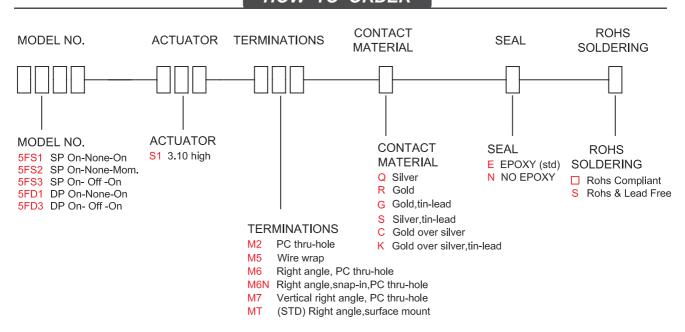
MATERIALS

CASE - Diallyl phthalate (DAP)(UL94V-0)

HOUSING - Brass,tin plated
ACTUATOR - Nylon, black.
CONTACT - Silver or gold plated.

TERMINALS - Copper alloy, with silver and gold plated. (See Page 98)

HOW TO ORDER



5F



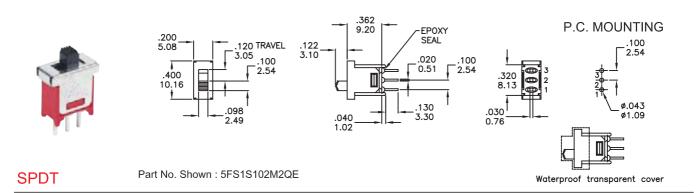
Sub-Miniature Slide Switches

SWITCH FUNCTION

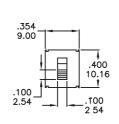
	UL/CSA		SWITCH FUNCTION		CONNECTED TERMINALS / SCHEMATIC			
NO.	MODEL	MODEL	POS.1	POS.2	POS.3	POS.1	POS.2	POS.3
LOLLO	NO.	NO.			4			4
	Q2511	5FS1	ON	NONE	ON	2-1 У експию	OPEN	2-3 \2(CDMH)
SP	Q2512	5FS2	ON	NONE	MOM			
	Q2513	5FS3	ON	OFF	ON	1 43		1. /3
DP	Q2521	5FD1	ON	NONE	ON	2-1,5-4	OPEN	2-3,5-6
00	Q2523	5FD3	ON	OFF	ON	1 -3 4 -6		1. 2CCDMM) 5 1. 3 4. 6

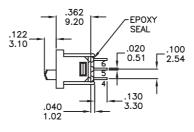
MOM=MOMENTARY

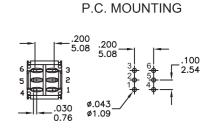
POLE OPTIONS











DPDT

Part No. Shown: 5FD1S102M2QE

TERMINATION OPTIONS

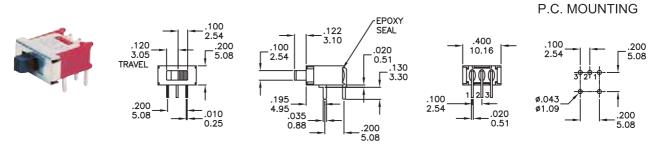
M2 PC THRU-HOLE EPOXY SEAL .130 .3.30 EPOXY SEAL .030 .200 .5.08 DP

M6 RIGHT ANGLE P.C. MOUNT M6N SNAP - IN RIGHT ANGLE P.C. MOUNT



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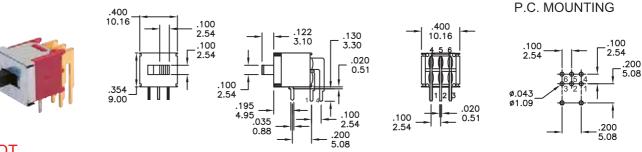




SPDT

Part No. Shown: 5FS1S102M6QE

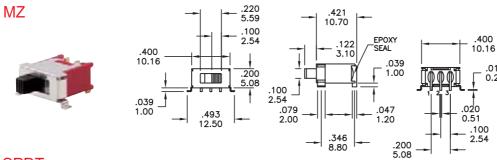




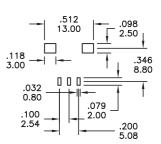
DPDT

Part No. Shown: 5FD1S102M6QE





P.C. MOUNTING

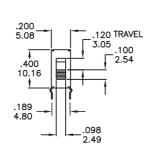


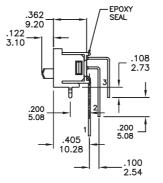
SPDT

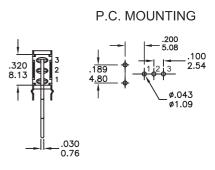
Part No. Shown: 5FS1S102MZRES

M7









Part No. Shown: 5FS1S102M7NRES

SNAP-IN **TERMINATION**

M6N







CONTACT MATERIAL OPTIONS

	CONTACT MATERIAL	TERMINAL PLATING	RATINGS	
Q	Silver	Q = Silver	3 Amps with resistant load @ 120VAC or 28VDC 1 Amps with resistant load @ 250VAC	
S	Silvei	S = Silver,pure - tin		
C K	Gold over Silver	C = Gold over silver		
K	Gold over Sliver	K = Gold over silver,pure - tin		
R	0-1-1	R = Gold	0.4 Volt-Amps(VA)max. @ 20V max. (AC or DC)	
G	Gold	G = Gold,pure - tin		







SOLDERING PROCESSES

MANUAL SOLDERING: Use soldering iron of 30 watts, controlled at 350°C approximately 5 seconds while applying solder.

WAVE SOLDERING: Recommended Soldering Temperature: 260±5°C

Duration of Solder Immersion: 5 ±1 seconds (PCB is 1.6mm in thickness)

SOLDERING: Vapor phase

Temperature Profile

Zone	Room temperature	Time (Sec)
Pre-heat (A)	150°C	Min 120s
Soak (B)	180°C~200°C	Min 150s
Peak (C)	200°C~235°C	Min 30s
Peak (D)	235°C~260°C	Min 40s
Peak (E)	260°C	Max 10s

